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July 2013

FDMC7208S

Dual N-Channel PowerTrench[®] MOSFET Q1: 30 V, 12 A, 9.0 m Ω Q2: 30 V, 16 A, 6.4 m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 9.0 m Ω at V_{GS} = 10 V, I_D = 12 A
- Max $r_{DS(on)}$ = 11.0 m Ω at V_{GS} = 4.5 V, I_D = 11 A

Q2: N-Channel

- Max $r_{DS(on)}$ = 6.4 m Ω at V_{GS} = 10 V, I_D = 16 A
- Max $r_{DS(on)}$ = 7.5 m Ω at V_{GS} = 4.5 V, I_D = 13.5 A
- Termination is Lead-free and RoHS Compliant

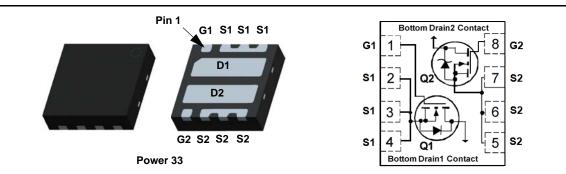


General Description

This device includes two 30V N-Channel MOSFETs in a dual Power 33 (3 mm X 3 mm MLP) package. The package is enhanced for exceptional thermal performance.

Applications

- Computing
- Communications
- General Purpose Point of Load
- Notebook System



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V _{DS}	Drain to Source Voltage		30	30	V
V _{GS}	Gate to Source Voltage	(Note 4)	±20	±12	V
	Drain Current -Continuous (Package limited)	T _C = 25 °C	22	26	
I _D	-Continuous	T _A = 25 °C	12 ^{1a}	16 ^{1b}	Α
	-Pulsed		60	80	
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	21	21	mJ
ם	Power Dissipation for Single Operation	T _A = 25 °C	1.9 ^{1a}	1.9 ^{1b}	w
PD	Power Dissipation for Single Operation	T _A = 25 °C	0.8 ^{1c}	0.8 ^{1d}	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to	+150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	65 ^{1a}	65 ^{1b}	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	155 ^{1c}	155 ^{1d}	C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC7208S	FDMC7208S	Power 33	13 "	12 mm	3000 units

FDMC7208S	
Dual N-Channel	
PowerTrench [®]	
MOSFET	

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ $I_D = 1 \ m A, \ V_{GS} = 0 \ V$	Q1 Q2	30 30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ m$ A, referenced to 25 °C	Q1 Q2		27 21		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V	Q1 Q2			1 500	μA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$ $V_{GS} = 12 V, V_{DS} = 0 V$	Q1 Q2			100 100	nA
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ $I_D = 1 \ mA, \ V_{GS} = 0 \ V$	Q1 Q2	1.2 1.2	1.7 1.6	3.0 3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ m$ A, referenced to 25 °C	Q1 Q2		-5 -3		mV/°C
	Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 11 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$	Q1		6.7 8.8 9.2	9.0 11.0 12.4	mΩ
r _{DS(on)}	Drain to Source On Resistance		Q2		4.7 5.3 6.4	6.4 7.5 6.8	1115.2
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 12 A$ $V_{DS} = 5 V$, $I_D = 16 A$	Q1 Q2		53 80		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	Q1: V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2		848 1685	1130 2245	pF
C _{oss}	Output Capacitance	Q2:	Q1 Q2		270 432	360 575	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2		36 42	55 65	pF

Electrical Characteristics $T_J = 25 \text{ °C}$ unless otherwise noted

Switching Characteristics

Gate Resistance

 R_g

t _{d(on)}	Turn-On Delay Time			Q1 Q2	6 7	12 14	ns
t _r	Rise Time	Q1: V _{DD} = 15 V, I _D = 12	2 A, $R_{GEN} = 6 \Omega$	Q1 Q2	2 3	10 10	ns
t _{d(off)}	Turn-Off Delay Time	Q2: V _{DD} = 15 V, I _D = 10	$6A$ $B_{0} = 60$	Q1 Q2	16 23	29 36	ns
t _f	Fall Time	VDD - 10 V, 10 - 1	57, NGEN - 032	Q1 Q2	2 2	10 10	ns
Qg	Total Gate Charge	$V_{GS} = 0$ V to 10 V		Q1 Q2	13 26	18 36	nC
Qg	Total Gate Charge	$V_{GS} = 0$ V to 5 V	V _{DD} = 15 V, I _D = 12 A	Q1 Q2	6.7 14	9.4 20	nC
Q _{gs}	Gate to Source Gate Charge		Q2 V _{DD} = 15 V,	Q1 Q2	2.3 3.9		nC
Q _{gd}	Gate to Drain "Miller" Charge		I _D = 16 A	Q1 Q2	1.8 2.7		nC

1.1

1.0

2.5

2.5

Ω

Q1

Q2

0.1

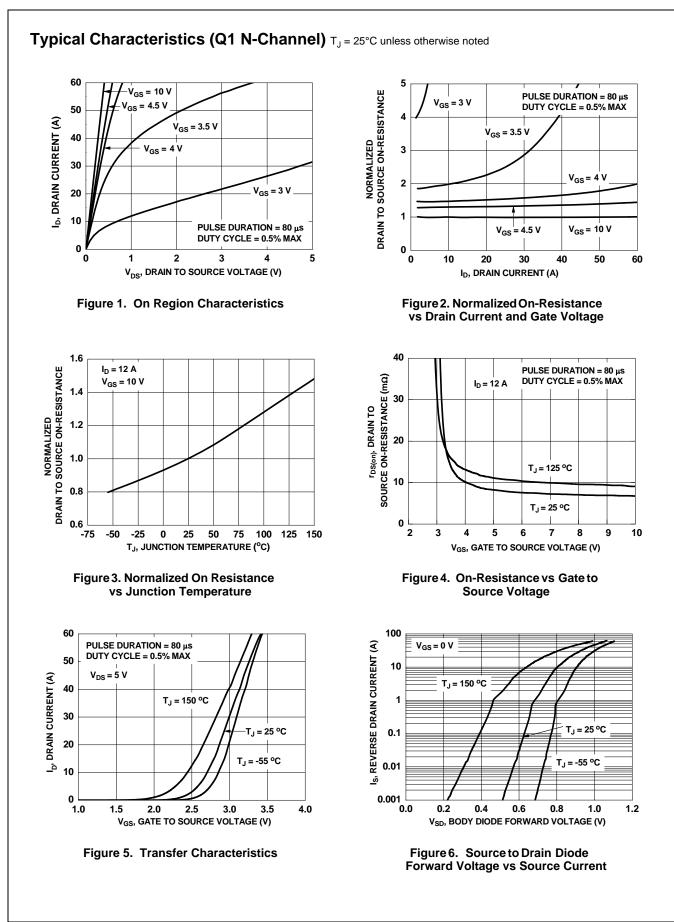
0.1

FDMC7208S
Duall
N-Channel
PowerTrench
[®] MOSFET

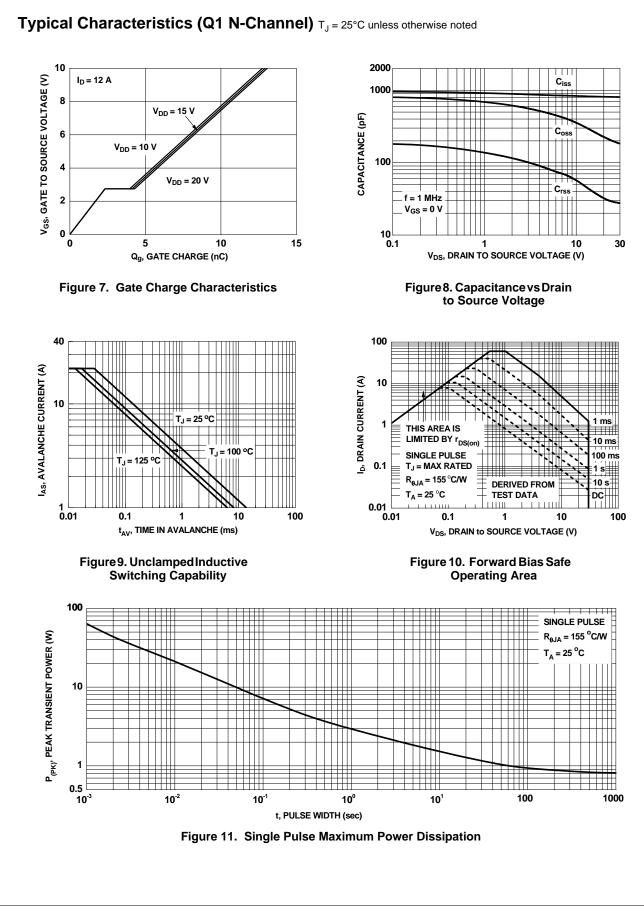
Symbol	Parameter	Test Co	nditions	Туре	Min	Тур	Max	Units
Drain-Soເ	urce Diode Characteristics							
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 V_{GS} = 0 V, I_S = 1 V_{GS} = 0 V, I_S = 1 V_{GS} = 0 V, I_S = 2 V_{GS} = 0 V, I_S = 1$	2 A (Note 2) A (Note 2)	Q1 Q2		0.72 0.82 0.70 0.82	1.2 1.2 1.2 1.2	V
t _{rr}	Reverse Recovery Time	Q1 I _F = 12 A, di/dt =	100 A/us	Q1 Q2		21 21	34 33	ns
Q _{rr}	Reverse Recovery Charge	$Q_{E} = 16 \text{ A, di/dt} =$	·	Q1 Q2		6 16	12 28	nC
	@ 편2% # %		۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ ۵ 8 8 8 8 8 8					
	c. 155 °C/W when mo minimum pad of 2 o	unted on a				mounted or 2 oz coppe		

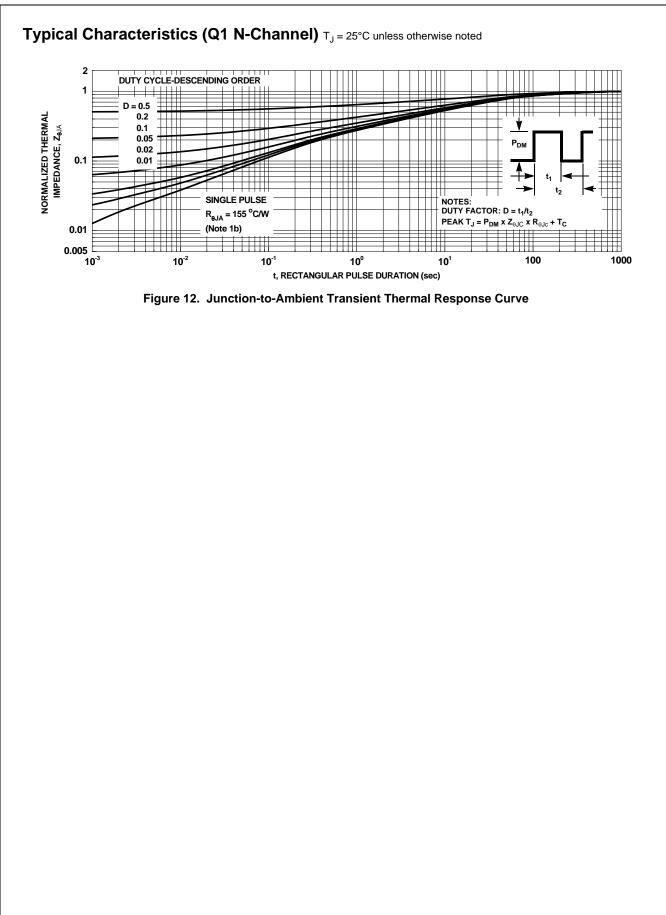
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Q1: E_{AS} of 21 mJ is based on starting T_J = 25 $^{\circ}$ C, L = 0.3 mH, I_{AS} = 12 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% tested at L = 3 mH, I_{AS} = 5.2 A. Q1: E_{AS} of 21 mJ is based on starting T_J = 25 $^{\circ}$ C, L = 0.3 mH, I_{AS} = 12 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% tested at L = 3 mH, I_{AS} = 5.4 A. 4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied

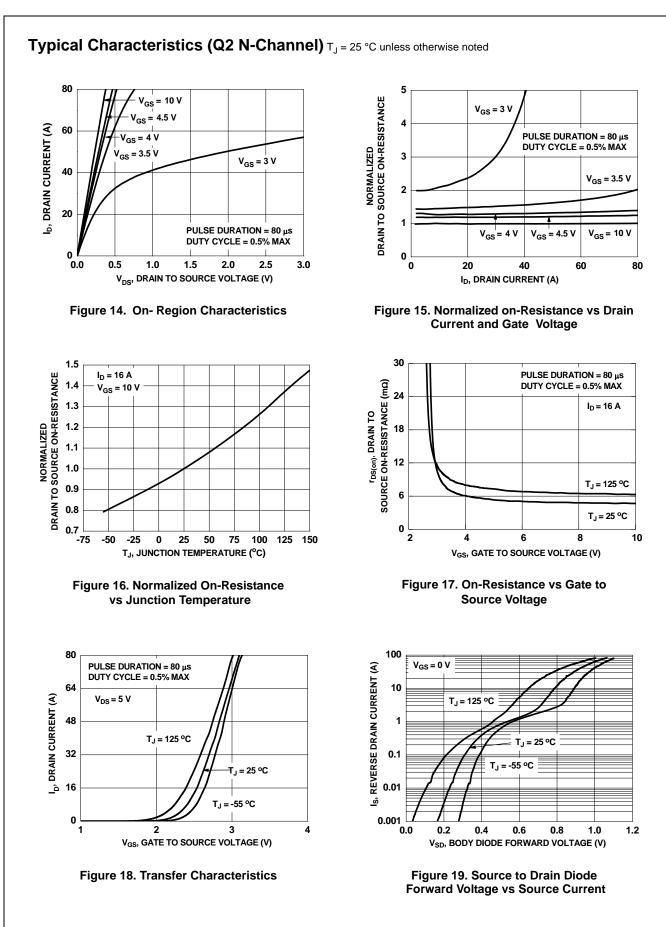




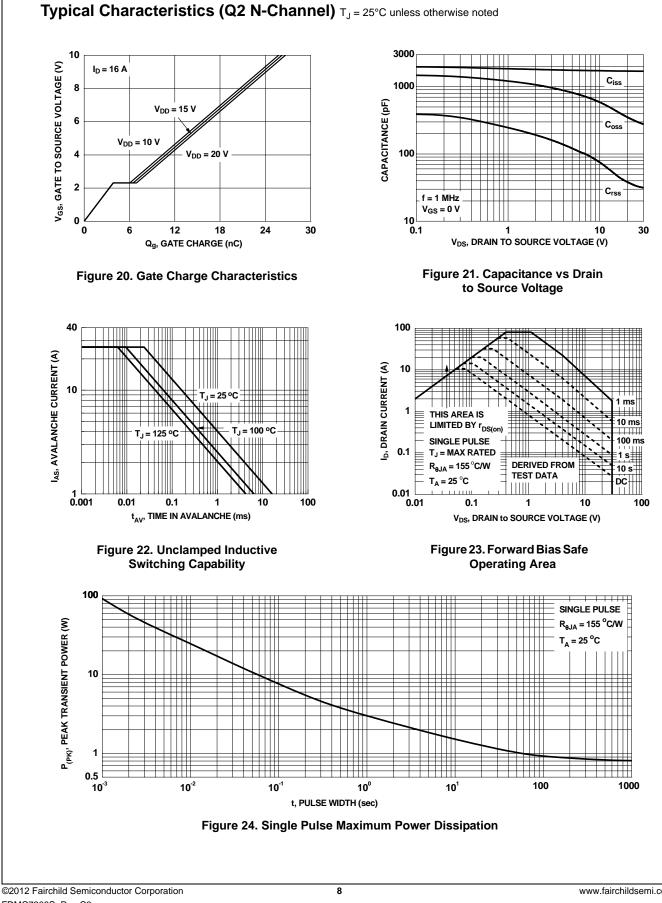


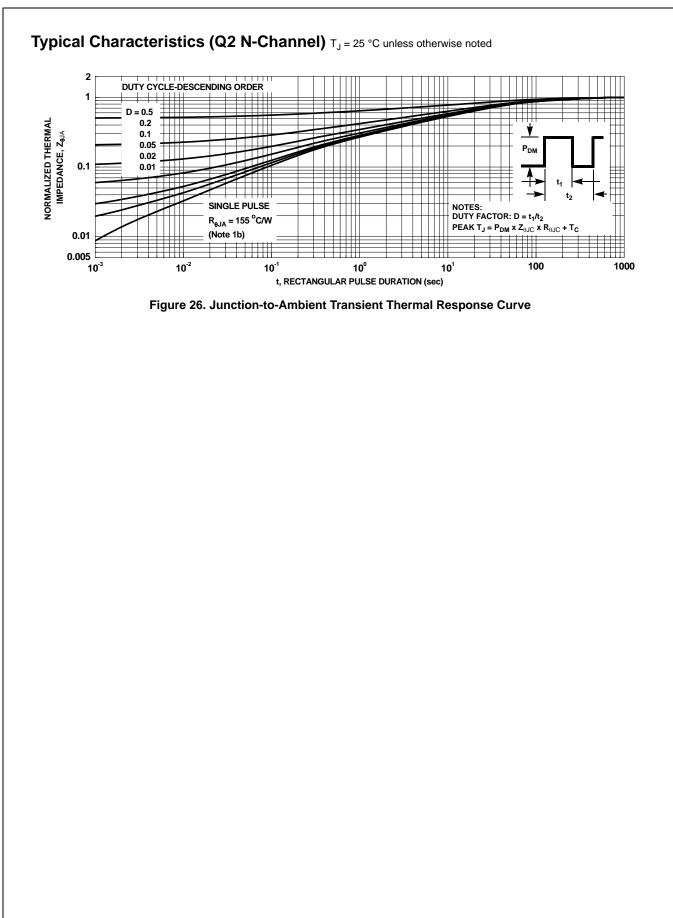










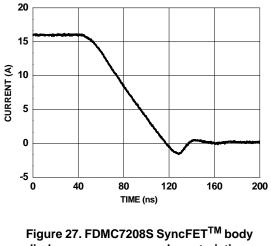


FDMC7208S Dual N-Channel PowerTrench[®] MOSFET

Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 27 shows the reverses recovery characteristic of the FDMC7208S.



diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

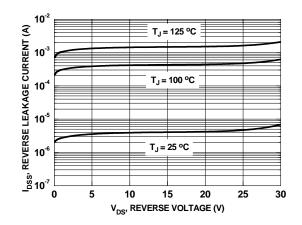
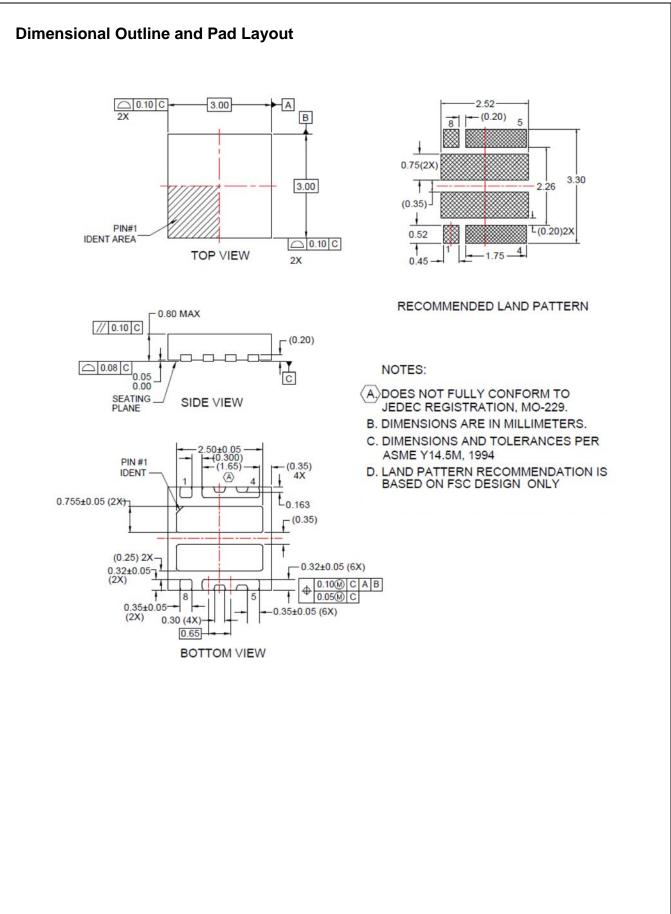


Figure 28. SyncFET[™] body diode reverses leakage versus drain-source voltage



FDMC7208S Dual N-Channel PowerTrench[®] MOSFET



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